



2M x 16 Bits x 4 Banks Synchronous DRAM

FEATURES

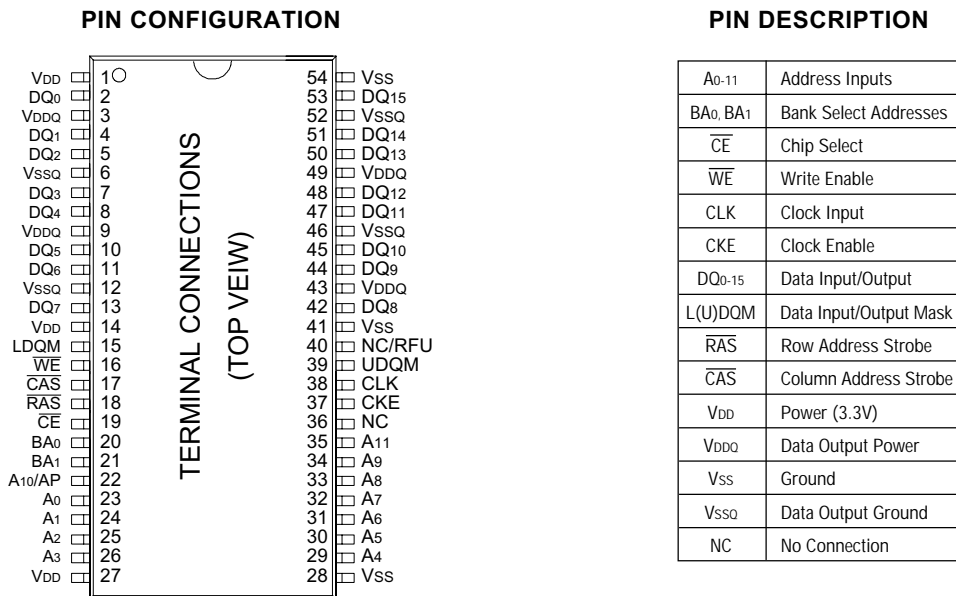
- Single 3.3V power supply
- Fully Synchronous to positive Clock Edge
- Clock Frequency = 100, 83MHz
- SDRAM CAS Latency = 3 (100MHz), 2 (83MHz)
- Burst Operation
 - Sequential or Interleave
 - Burst length = programmable 1,2,4,8 or full page
 - Burst Read and Write
 - Multiple Burst Read and Single Write
- DATA Mask Control per byte
- Auto Refresh (CBR) and Self Refresh
 - 4096 refresh cycles across 64ms
- Automatic and Controlled Precharge Commands
- Suspend Mode and Power Down Mode
- Industrial Temperature Range

DESCRIPTION

The WED416S8030A is 134,217,728 bits of synchronous high data rate DRAM organized as 4 x 2,097,152 words x 16 bits. Synchronous design allows precise cycle control with the use of system clock, I/O transactions are possible on every clock cycle. Range of operating frequencies, programmable burst lengths and programmable latencies allow the same device to be useful for a variety of high bandwidth, high performance memory system applications.

Available in a 54 pin TSOP type II package the WED416S8030A is tested over the industrial temp range (-40°C to +85°C) providing a solution for rugged main memory applications.

FIG. 1





INPUT/OUTPUT FUNCTIONAL DESCRIPTION

Symbol	Type	Signal	Polarity	Function
CLK	Input	Pulse	Positive Edge	The system clock input. All of the SDRAM inputs are sampled on the rising edge of the clock.
CKE	Input	Level	Active High	Activates the CLK signal when high and deactivates the CLK signal when low. By deactivating the clock, CKE low initiates the Power Down mode, Suspend mode, or the Self Refresh mode.
\overline{CE}	Input	Pulse	Active Low	\overline{CE} disable or enable device operation by masking or enabling all inputs except CLK, CKE and DQM.
\overline{RAS} , \overline{CAS} \overline{WE}	Input	Pulse	Active Low	When sampled at the positive rising edge of the clock, \overline{CAS} , \overline{RAS} , and \overline{WE} define the operation to be executed by the SDRAM.
BA ₀ , BA ₁	Input	Level	—	Selects which SDRAM bank is to be active.
A ₀₋₁₁ , A _{10/AP}	Input	Level	—	<p>During a Bank Activate command cycle, A₀₋₁₁ defines the row address (RA₀₋₁₁) when sampled at the rising clock edge.</p> <p>During a Read or Write command cycle, A₀₋₈ defines the column address (CA₀₋₈) when sampled at the rising clock edge. In addition to the row address, A_{10/AP} is used to invoke Autoprecharge operation at the end of the Burst Read or Write cycle. If A_{10/AP} is high, autoprecharge is selected and BA₀, BA₁ defines the bank to beprecharged . If A_{10/AP} is low, autoprecharge is disabled.</p> <p>During a Precharge command cycle, A_{10/AP} is used in conjunction with BA₀, BA₁ to control which bank(s) to precharge. If A_{10/AP} is high, all banks will be precharged regardless of the state of BA₀, BA₁. If A_{10/AP} is low, then BA₀, BA₁ is used to define which bank to precharge.</p>
DQ ₀₋₁₅	Input/Output	Level	—	Data Input/Output are multiplexed on the same pins.
L(U)DQM	Input	Pulse	Mask Active High	The Data Input/Output mask places the DQ buffers in a high impedance state when sampled high. In Read mode, DQM has a latency of two clock cycles and controls the output buffers like an output enable. In Write mode, DQM has a latency of zero and operates as a word mask by allowing input data to be written if it is lowbut blocks the Write operation if DQM is high.
V _{DD} , V _{SS}	Supply			Power and ground for the input buffers and the core logic.
V _{DD0} , V _{SS0}	Supply			Isolated power and ground for the output buffers to improve noise immunity.

**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Min	Max	Units
Power Supply Voltage	V _{DD}	-1.0	+4.6	V
Input Voltage	V _{IN}	-1.0	+4.6	V
Output Voltage	V _{OUT}	-1.0	+4.6	V
Operating Temperature	T _{OPR}	-40	+85	°C
Storage Temperature	T _{STG}	-55	+125	°C
Power Dissipation	P _D		1.0	W
Short Circuit Output Current	I _{OS}		50	mA

Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS

(Voltage Referenced to: V_{SS} = 0V, T_A = -40°C to +85°C)

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Supply Voltage	V _{DD}	3.0	3.3	3.6	V	
Input High Voltage	V _{IH}	2.0	3.0	V _{DD} + 0.3	V	
Input Low Voltage	V _{IL}	-0.3	—	0.8	V	
Output High Voltage	V _{OH}	2.4	—	—	V	(I _{OH} = -2mA)
Output Low Voltage	V _{OL}	—	—	0.4	V	(I _{OL} = 2mA)
Input Leakage Voltage	I _{IL}	-5	—	5	μA	
Output Leakage Voltage	I _{OL}	-5	—	5	μA	

CAPACITANCE

(T_A = 25°C, f = 1MHz, V_{DD} = 3.3V to 3.6V)

Parameter	Symbol	Max	Unit
Input Capacitance (A ₀₋₁₁ , BA ₀₋₁)	C _{I1}	4	pF
Input Capacitance (CLK, CKE, $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, WE, $\overline{\text{CE}}$, DQM)	C _{I2}	4	pF
Input/Output Capacitance (DQ ₀₋₁₅)	C _{OUT}	5	pF

OPERATING CURRENT CHARACTERISTICS

(V_{CC} = 3.3V, T_A = -40°C to +85°C)

Parameter	Symbol	Test Condition	-10	-12	Units	Notes
Operating Current (One Bank Active)	ICC1	Burst Length = 1, t _{trc} ≥ t _{trc} (min)	140	125	mA	1
Operating Current (Burst Mode)	ICC4	Page Burst, 2 banks active, t _{CCD} = 2 clocks	200	165	mA	1
Precharge Standby Current in Power Down Mode	ICC2P	CKE ≤ V _{IL} (max), t _{CC} = 15ns	2	2	mA	
	ICC2PS	CKE, CLK ≤ V _{IL} (max), t _{CC} = ∞, Inputs Stable	2	2	mA	
Precharge Standby Current in Non-Power Down Mode	ICC1N	CKE = V _{IH} , t _{CC} = 15ns Input Change every 30ns	50	50	mA	
	ICC1NS	CKE ≥ V _{IH} (min), t _{CC} = ∞ No Input Change	35	35	mA	
Active Standby Current in Power Down Mode	ICC3P	CKE ≤ V _{IL} (max), t _{CC} = 15ns	12	12	mA	
	ICC3PS	CKE ≤ V _{IL} (max), t _{CC} = ∞	12	12	mA	
Active Standby Current in Non-Power Down Mode	ICC2N	CKE = V _{IH} , t _{CC} = 15ns Input Change every 30ns	30	30	mA	
	ICC2NS	CKE ≥ V _{IH} (min), t _{CC} = ∞, No Input Change	20	20	mA	
Refresh Current	ICC5	t _{trc} ≥ t _{trc} (min)	210	210	mA	2
Self Refresh Current	ICC6	CKE ≤ 0.2V	3	3	mA	

NOTES:

1. Measured with outputs open.
2. Refresh period is 64ms.



AC CHARACTERISTICS

OPERATING AC PARAMETERS

(V_{CC} = 3.3V, T_A = -40°C to +85°C)

Parameter		Symbol	-10		-12		Units	Notes
			Min	Max	Min	Max		
Clock Cycle Time	CAS latency = 3	t _{CC}	10	1000	12	1000	ns	1
	CAS latency = 2		13	1000	15	1000		
Clock to Valid Output Delay		t _{SAC}		7		8	ns	1, 2
Output Data Hold Time		t _{OH}	3		3		ns	2
Clock High Pulse Width		t _{CH}	3.5		4.0		ns	3
Clock Low Pulse Width		t _{CL}	3.5		4.0		ns	3
Input Setup Time		t _{SS}	2.5		3		ns	3
Input Hold Time		t _{SH}	1		1		ns	3
Clock to Output in Low-Z		t _{SLZ}	1		1		ns	2
Clock to Output in High-Z		t _{SHZ}		7		8	ns	
Row Active to Row Active Delay		t _{RRD}	20		24		ns	4
RAS to CAS Delay		t _{RCD}	24		26		ns	4
Row Precharge Time		t _{RP}	24		26		ns	4
Row Active Time		t _{RAS}	50	100,000	60	100,000	ns	4
Row Cycle Time - Operation		t _{RC}	80		90		ns	4
Row Cycle Time - Auto Refresh		t _{RFC}	80		90		ns	4, 8
Last Data In to New Column Address Delay		t _{CDL}	1		1		CLK	5
Last Data In to Row Precharge		t _{RDL}	1		1		CLK	5
Last Data In to Burst Stop		t _{BDL}	1		1		CLK	5
Column Address to Column Address Delay		t _{CCD}	1		1		CLK	6
Number of Valid Output Data	CAS latency = 3		2		2		ea	7
	CAS latency = 2		1		1			

NOTES:

- Parameters depend on programmed CAS latency.
- If clock rise time is longer than 1ns, (t_{rise} 2-0.5)ns should be added to the parameter.
- Assumed input rise and fall time = 1ns. If t_{rise} & t_{fall} are longer than 1ns, [(t_{rise} + t_{fall})/2]-1ns should be added to the parameter.
- The minimum number of clock cycles required is determined by dividing the minimum time required by the clock cycle time and then rounding up to the next higher integer.
- Minimum delay is required to complete write.
- All devices allow every cycle column address changes.
- In case of row precharge interrupt, auto precharge and read burst stop.
- A new command may be given t_{RFC} after self refresh exit.

REFRESH CYCLE PARAMETERS

Parameter	Symbol	-10		-12		Units	Notes
		Min	Max	Min	Max		
Refresh Period	t _{REF}	—	64	—	64	ms	1, 2
Self Refresh Exit Time	t _{SREX}	t _{RFC}	—	t _{RFC}	—	ns	3

NOTES:

- 4096 cycles.
- Any time that the Refresh Period has been exceeded, a minimum of two Auto (CBR) Refresh commands must be given to "wake-up" the device.
- The self refresh is exited by restarting the external clock and then asserting CKE high. This must be followed by NOPs for a minimum time of t_{RFC} before the SDRAM reaches idle state to begin normal operation.



CLOCK FREQUENCY AND LATENCY PARAMETERS - 100MHz

(Units = number of clocks)

Frequency	CAS Latency	trc	trAS	trP	trRD	trCD	tCCD	tCDL	trDL
		80ns	50ns	24ns	20ns	24ns	10ns	10ns	10ns
100MHz (10ns)	3	8	5	3	2	3	1	1	1
83MHz (12ns)	3	7	5	2	2	2	1	1	1
75MHz (12ns)	2	6	4	2	2	2	1	1	1
66MHz (15ns)	2	6	4	2	2	2	1	1	1

CLOCK FREQUENCY AND LATENCY PARAMETERS - 83MHz

(Units = number of clocks)

Frequency	CAS Latency	trc	trAS	trP	trRD	trCD	tCCD	tCDL	trDL
		90ns	60ns	26ns	24ns	26ns	12ns	12ns	12ns
83MHz (12ns)	3	8	5	3	2	3	1	1	1
75MHz (13ns)	3	7	5	2	2	2	1	1	1
66MHz (15ns)	2	6	4	2	2	2	1	1	1



COMMAND TRUTH TABLE

Command		CKE		\overline{CE}	\overline{RAS}	\overline{CAS}	\overline{WE}	DQM	BA	A10/Ap	A11, A9-0	Notes
		Previous Cycle	Current Cycle									
Register	Mode Register Set	H	X	L	L	L	L	X	OP CODE			
Refresh	Auto(CBR)	H	H	L	L	L	H	X	X	X	X	
	Entry Self		L									
Precharge	Single Bank	H	X	L	L	H	L	X	BA	L	X	2
	All Banks								X	H	X	
Bank Activate		H	X	L	L	H	H	X	BA	Row Address		2
Write	Auto Precharge Disable	H	X	L	H	L	L	X	BA	L	Column Address	2
	Auto Precharge Enable									H		2
Read	Auto Precharge Disable	H	X	L	H	L	H	X	BA	L	Column Address	2
	Auto Precharge Enable									H		2
Burst Stop		H	X	L	H	H	L	X	X	X	X	3
No Operation		H	X	L	H	H	H	X	X	X	X	
Device Deselect		H	X	H	X	X	X	X	X	X	X	
Clock Suspend/Standby Mode		L	X	X	X	X	X	X	X	X	X	4
Data	Write/Output Enable	H	X	X	X	X	X	L	X	X	X	5
	Mask/Output Disable							H				
Power Down Mode	Entry	X	L	H	X	X	X	X	X	X	X	6
	Exit		H									6

(X = Don't Care, H = Logic High, L = Logic Low)

NOTES:

- All of the SDRAM operations are defined by states of \overline{CE} , \overline{WE} , \overline{RAS} , \overline{CAS} , and DQM at the positive rising edge of the clock.
- Bank Select (BA), if BA₀, BA₁ = 0, 0 then bank A is selected, if BA₀, BA₁ = 1, 0 then bank B, if BA₀, BA₁ = 0, 1 then bank C, if BA₀, BA₁ = 1, 1 then bank D is selected, respectively.
- During a Burst Write cycle there is a zero clock delay, for a Burst Read cycle the delay is equal to the CAS latency.
- During normal access mode, CKE is held high and CLK is enabled. When it is low, it freezes the internal clock and extends data Read and Write operations. One clock delay is required for mode entry and exit.
- The DQM has two functions for the data DQ Read and Write operations. During a Read cycle, when DQM goes high at a clock timing the data outputs are disabled and become high impedance after a two clock delay. DQM also provides a data mask function for Write cycles. When it activates, the Write operation at the clock is prohibited (zero clock latency).
- All banks must be precharged before entering the Power Down Mode. The Power Down Mode does not perform any Refresh operations, therefore the device can't remain in this mode longer than the Refresh period (t_{REF}) of the device. One clock delay is required for mode entry and exit.

CLOCK ENABLE (CKE₀) TRUTH TABLE

Current State	CKE		Command						Action	Notes
	Previous	Current	\overline{CE}	\overline{RAS}	\overline{CAS}	\overline{WE}	BA	A ₀₋₁₁		
Self Refresh	H	X	X	X	X	X	X	X	INVALID	1
	L	H	H	X	X	X	X	X	Exit Self Refresh with Device Deselect	2
	L	H	L	H	H	H	X	X	Exit Self Refresh with No Operation	2
	L	H	L	H	H	L	X	X	ILLEGAL	2
	L	H	L	H	L	X	X	X	ILLEGAL	2
	L	L	X	X	X	X	X	X	Maintain Self Refresh	
Power Down	H	X	X	X	X	X	X	X	INVALID	1
	L	H	H	X	X	X	X	X	Power Down Mode exit, all banks idle	2
	L	H	L	X	X	X	X	X	ILLEGAL	2
	L	L	X	X	X	X	X	X	Maintain Power Down Mode	
All Banks Idle	H	H	H	X	X	X			Refer to the Idle State section of the Current State Truth Table	3
	H	H	L	H	X	X				
	H	H	L	L	H	X				
	H	H	L	L	L	H	X	X	CBR Refresh	
	H	H	L	L	L	L	OP Code		Mode Register Set	4
	H	L	H	X	X	X			Refer to the Idle State section of the Current State Truth Table	3
	H	L	L	H	X	X				
	H	L	L	L	H	X				
	H	L	L	L	L	H	X	X	Entry Self Refresh	4
	H	L	L	L	L	L	OP Code		Mode Register Set	
L	X	X	X	X	X	X	X	Power Down	4	
Any State other than listed above	H	H	X	X	X	X	X	X	Refer to the Operations in the Current State Truth Table	
	H	L	X	X	X	X	X	X	Begin Clock Suspend next cycle	5
	L	H	X	X	X	X	X	X	Exit Clock Suspend next cycle	
	L	L	X	X	X	X	X	X	Maintain Clock Suspend	

NOTES:

- For the given Current State CKE must be low in the previous cycle.
- When CKE has a low to high transition, the clock and other inputs are re-enabled asynchronously. The minimum setup time for CKE (t_{CKS}) must be satisfied before any command other than Exit is issued.
- The address inputs (A₁₂₋₀) depend on the command that is issued. See the Idle State section of the Current State Truth Table for more information.
- The Power Down Mode, Self Refresh Mode, and the Mode Register Set can only be entered from the all banks idle state. Must be a legal command as defined in the Current State Truth Table.



CURRENT STATE TRUTH TABLE

Current State	Command						Description	Action	Notes
	\overline{CE}	\overline{RAS}	\overline{CAS}	\overline{WE}	BA	A ₁₁ , A _{10/AP-A₀}			
Idle	L	L	L	L		OP Code	Mode Register Set	Set the Mode Register	2
	L	L	L	H	X	X	Auto orSelf Refresh	Start Auto orSelf Refresh	2,3
	L	L	H	L	X	X	Precharge	No Operation	
	L	L	H	H	BA	Row Address	Bank Activate	Activate the specified bank and row	
	L	H	L	L	BA	Column	Write w/o Precharge	ILLEGAL	4
	L	H	L	H	BA	Column	Read w/o Precharge	ILLEGAL	4
	L	H	H	L	X	X	Burst Termination	No Operation	
	L	H	H	H	X	X	No Operation	No Operation	
Row Active	H	X	X	X	X	X	Device Deselect	No Operation or Power Down	5
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	Precharge	6
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
	L	H	L	L	BA	Column	Write	Start Write; Determine if Auto Precharge	7,8
	L	H	L	H	BA	Column	Read	Start Read; Determine if Auto Precharge	7,8
	L	H	H	L	X	X	Burst Termination	No Operation	
Read	L	H	H	H	X	X	No Operation	No Operation	
	H	X	X	X	X	X	Device Deselect	No Operation	
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	Terminate Burst; Start the Precharge	
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
	L	H	L	L	BA	Column	Write	Terminate Burst; Start the Write cycle	8,9
	L	H	L	H	BA	Column	Read	Terminate Burst; Start a new Read cycle	8,9
Write	L	H	H	L	X	X	Burst Termination	Terminate the Burst	
	L	H	H	H	X	X	No Operation	Continue the Burst	
	H	X	X	X	X	X	Device Deselect	Continue the Burst	
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	Terminate Burst; Start the Precharge	
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
	L	H	L	L	BA	Column	Write	Terminate Burst; Start a new Write cycle	8,9
Read with Auto Precharge	L	H	L	H	BA	Column	Read	Terminate Burst; Start the Read cycle	8,9
	L	H	H	L	X	X	Burst Termination	Terminate the Burst	
	L	H	H	H	X	X	No Operation	Continue the Burst	
	H	X	X	X	X	X	Device Deselect	Continue the Burst	
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	ILLEGAL	4
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
Read with Auto Precharge	L	H	L	L	BA	Column	Write	ILLEGAL	
	L	H	L	H	BA	Column	Read	ILLEGAL	
	L	H	H	L	X	X	Burst Termination	ILLEGAL	
	L	H	H	H	X	X	No Operation	Continue the Burst	
	H	X	X	X	X	X	Device Deselect	Continue the Burst	



CURRENT STATE TRUTH TABLE (cont.)

Current State	Command						Description	Action	Notes
	\overline{CE}	\overline{RAS}	\overline{CAS}	\overline{WE}	BA	A ₁₁ , A ₁₀ /AP-A ₀			
Write with Auto Precharge	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	ILLEGAL	4
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
	L	H	L	L	BA	Column	Write	ILLEGAL	
	L	H	L	H	BA	Column	Read	ILLEGAL	
	L	H	H	L	X	X	Burst Termination	ILLEGAL	
	L	H	H	H	X	X	No Operation	Continue the Burst	
Precharging	H	X	X	X	X	X	Device Deselect	Continue the Burst	
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	No Operation; Bank(s) idle after t _{RP}	
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
	L	H	L	L	BA	Column	Write	ILLEGAL	4
	L	H	L	H	BA	Column	Read	ILLEGAL	4
	L	H	H	L	X	X	Burst Termination	No Operation; Bank(s) idle after t _{RP}	
Row Activating	L	H	H	H	X	X	No Operation	No Operation; Bank(s) idle after t _{RP}	
	H	X	X	X	X	X	Device Deselect	No Operation; Bank(s) idle after t _{RP}	
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	ILLEGAL	4
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4,10
	L	H	L	L	BA	Column	Write	ILLEGAL	4
	L	H	L	H	BA	Column	Read	ILLEGAL	4
Write Recovering	L	H	H	L	X	X	Burst Termination	No Operation; Row active after t _{RCD}	
	L	H	H	H	X	X	No Operation	No Operation; Row active after t _{RCD}	
	H	X	X	X	X	X	Device Deselect	No Operation; Row active after t _{RCD}	
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	ILLEGAL	4
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
	L	H	L	L	BA	Column	Write	Start Write; Determine if Auto Precharge	9
Write Recovering with Auto Precharge	L	H	L	H	BA	Column	Read	Start Read; Determine if Auto Precharge	9
	L	H	H	L	X	X	Burst Termination	No Operation; Row active after t _{OPL}	
	L	H	H	H	X	X	No Operation	No Operation; Row active after t _{OPL}	
	H	X	X	X	X	X	Device Deselect	No Operation; Row active after t _{OPL}	
	L	L	L	L		OP Code	Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	ILLEGAL	4
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	4
Write Recovering with Auto Precharge	L	H	L	L	BA	Column	Write	ILLEGAL	4,9
	L	H	L	H	BA	Column	Read	ILLEGAL	4,9
	L	H	H	L	X	X	Burst Termination	No Operation; Precharge after t _{OPL}	
	L	H	H	H	X	X	No Operation	No Operation; Precharge after t _{OPL}	
	H	X	X	X	X	X	Device Deselect	No Operation; Precharge after t _{OPL}	



CURRENT STATE TRUTH TABLE (cont.)

Current State	Command						Description	Action	Notes
	$\overline{\text{CE}}$	$\overline{\text{RAS}}$	$\overline{\text{CAS}}$	$\overline{\text{WE}}$	BA	A11, A10/AP-A0			
Refreshing	L	L	L	L	OP Code		Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	ILLEGAL	
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	
	L	H	L	L	BA	Column	Write	ILLEGAL	
	L	H	L	H	BA	Column	Read	ILLEGAL	
	L	H	H	L	X	X	Burst Termination	No Operation; Idle after t _{rc}	
	L	H	H	H	X	X	No Operation	No Operation; Idle after t _{rc}	
Mode Register Accessing	H	X	X	X	X	X	Device Deselect	No Operation; Idle after t _{rc}	
	L	L	L	L	OP Code		Mode Register Set	ILLEGAL	
	L	L	L	H	X	X	Auto orSelf Refresh	ILLEGAL	
	L	L	H	L	X	X	Precharge	ILLEGAL	
	L	L	H	H	BA	Row Address	Bank Activate	ILLEGAL	
	L	H	L	L	BA	Column	Write	ILLEGAL	
	L	H	L	H	BA	Column	Read	ILLEGAL	
	L	H	H	L	X	X	Burst Termination	ILLEGAL	
L	H	H	H	X	X	No Operation	No Operation; Idle after two clock cycles		
H	X	X	X	X	X	Device Deselect	No Operation; Idle after two clock cycles		

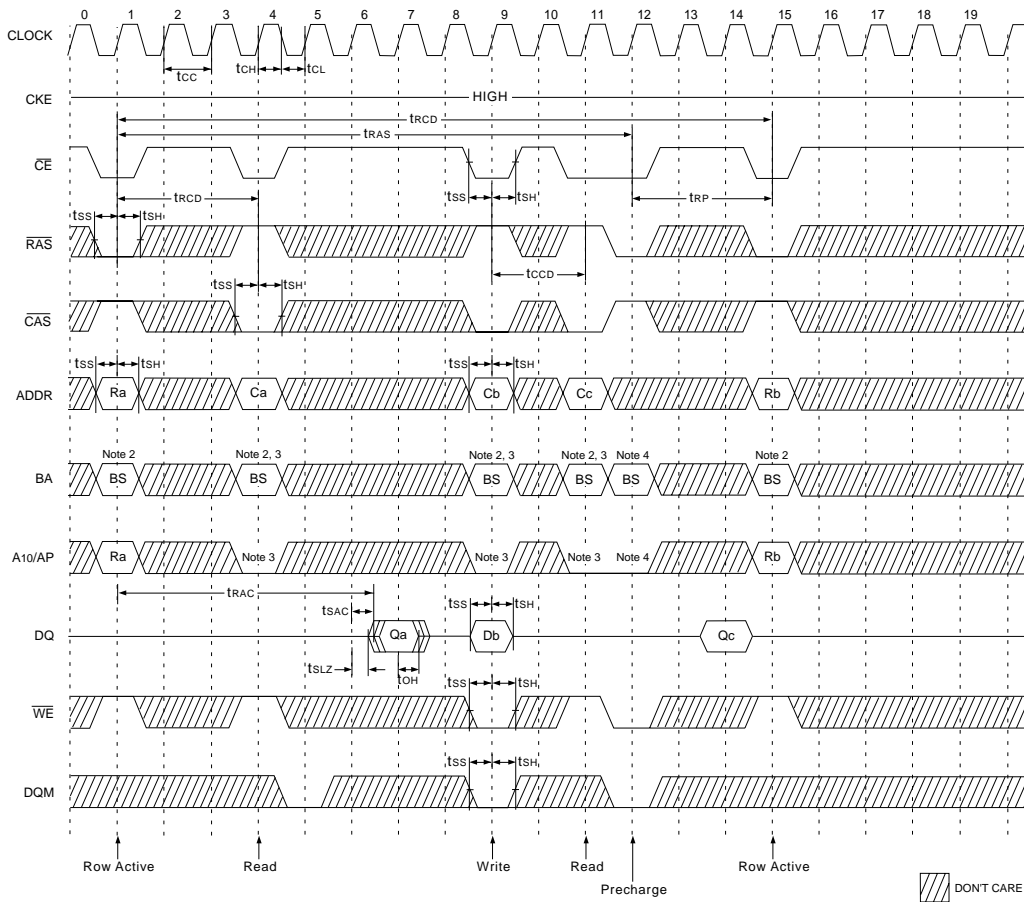
NOTES:

1. CKE is assumed to be active (high) in the previous cycle for all entries. The Current State is the state of the bank that the command is being applied to.
2. All Banks must be idle otherwise it is an illegal action.
3. If CKE is active (high) the SDRAM starts the Auto (CBR) Refresh operation, if CKE is inactive (low) then the Self Refresh mode is entered.
4. The Current State refers only to one of the banks, if BA₀, BA₁ selects this bank then the action is illegal. If BA₀, BA₁ selects the bank not being referenced by the Current State then the action may be legal depending on the state of that bank.
5. If CKE is inactive (low) then the Power Down mode is entered, otherwise there is a No Operation.
6. The minimum and maximum Active time (t_{RAS}) must be satisfied.
7. The $\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Delay (t_{RCB}) must occur before the command is given.
8. Address A10 is used to determine if the Auto Precharge function is activated.
9. The command must satisfy any bus contention, bus turn around, and/or write recovery requirements.

The command is illegal if the minimum bank to bank delay time (t_{RRD}) is not satisfied.



FIG. 2 SINGLE BIT READ-WRITE CYCLE (SAME PAGE) @CAS LATENCY=3, BURST LENGTH=1



NOTES:

1. All input except CKE & DQM can be don't care when CE is high at the CLK high going edge.
2. Bank active & read/write are controlled by BA₀-BA₁.

BA0	BA1	Active & Read/Write
0	0	Bank A
0	1	Bank B
1	0	Bank C
1	1	Bank D

4. A10/AP and BA₀-BA₁ control bank precharge when precharge command is asserted.

A10/AP	BA0	BA1	Precharge
0	0	0	Bank A
0	0	1	Bank B
0	1	0	Bank C
0	1	1	Bank D
1	x	x	All Banks

3. Enable and disable auto precharge function are controlled by A10/AP in read/write command.

A10/AP	BA0	BA1	Operation
0	0	0	Distribute auto precharge, leave bank A active at end of burst.
	0	1	Disable auto precharge, leave bank B active at end of burst.
	1	0	Disable auto precharge, leave bank C active at end of burst.
	1	1	Disable auto precharge, leave bank D active at end of burst.
1	0	0	Enable auto precharge, precharge bank A at end of burst.
	0	1	Enable auto precharge, precharge bank B at end of burst.
	1	0	Enable auto precharge, precharge bank C at end of burst.
	1	1	Enable auto precharge, precharge bank D at end of burst.



FIG. 3 POWER UP SEQUENCE

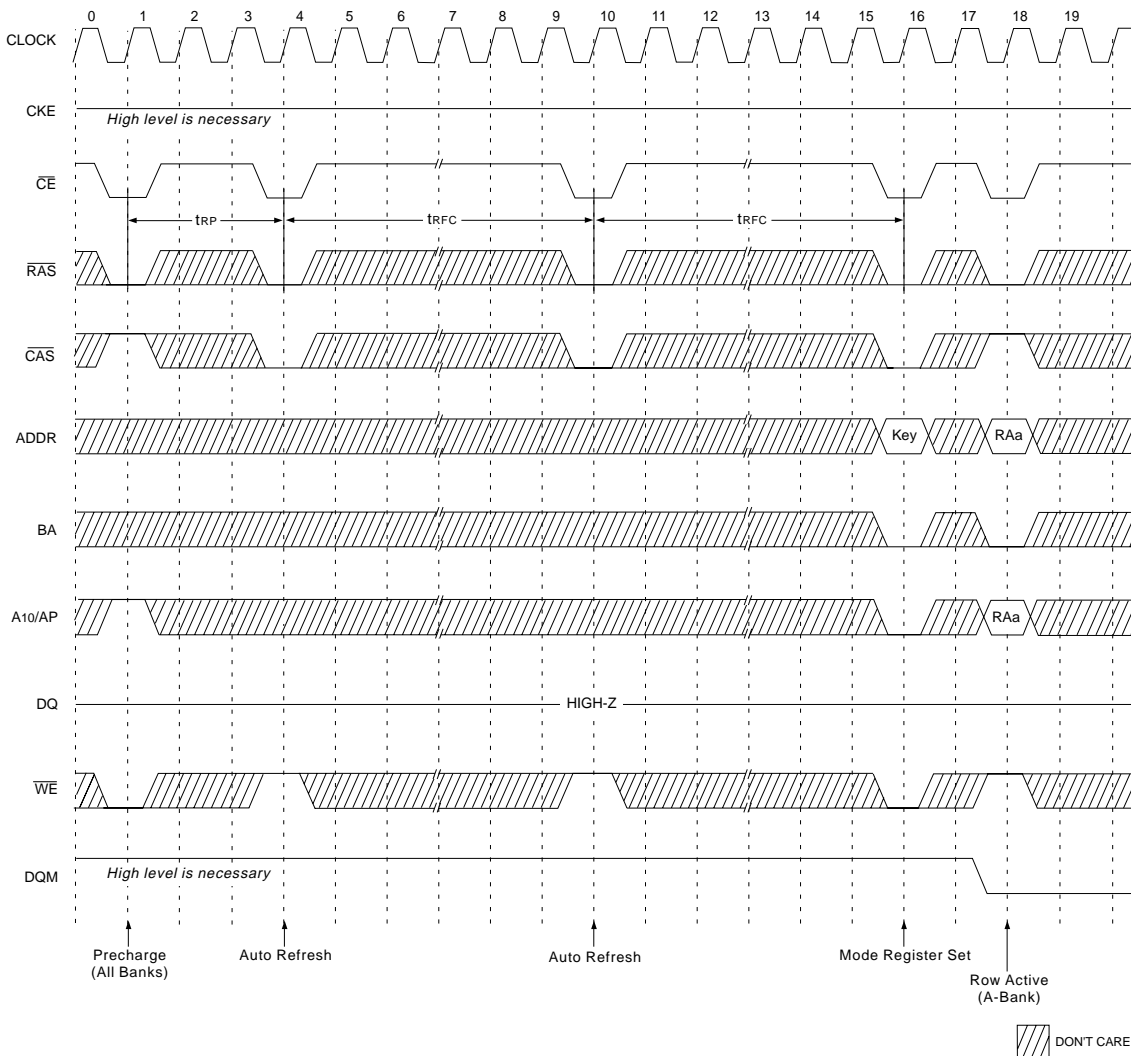
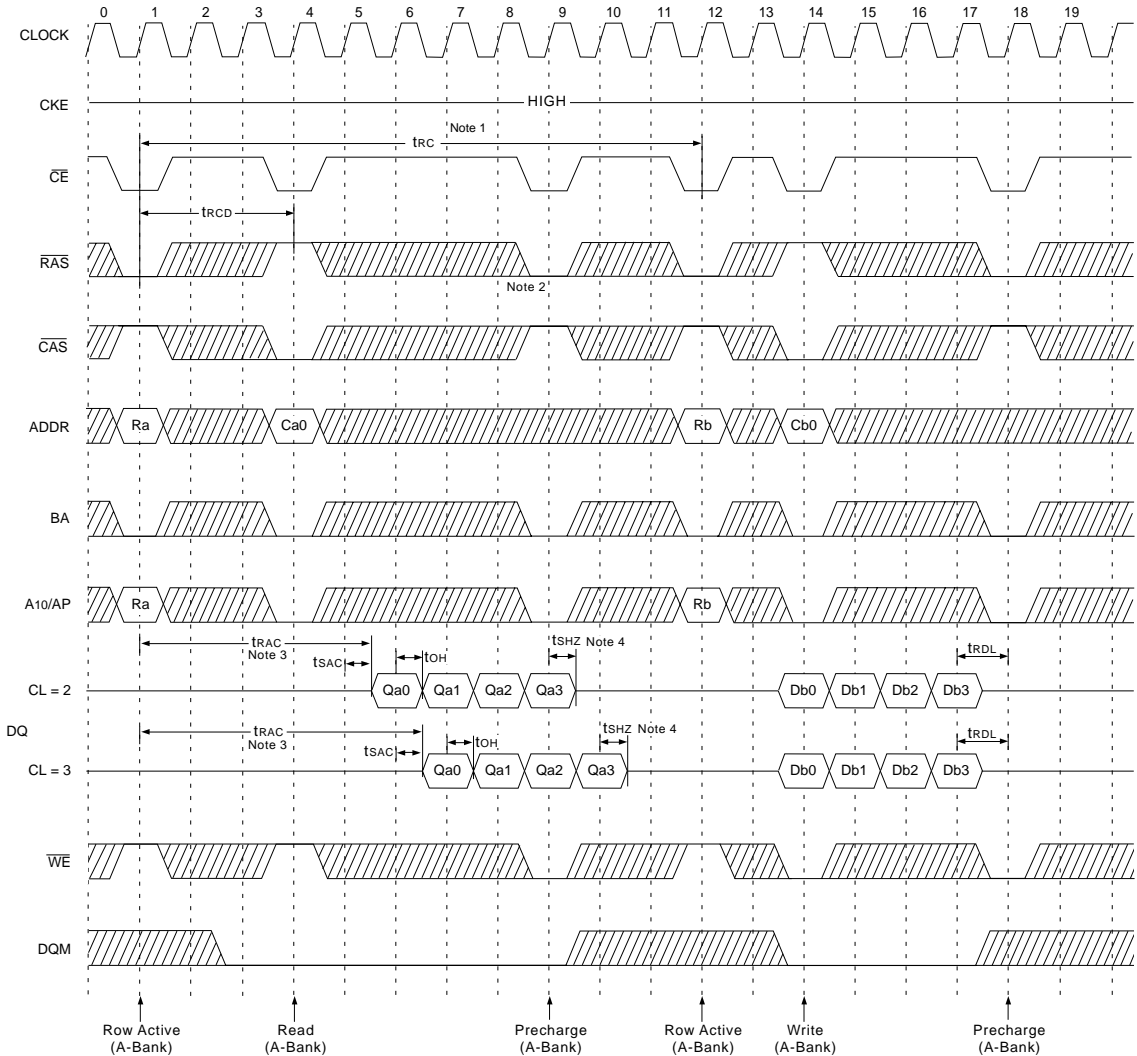




FIG. 4 READ & WRITE CYCLE AT SAME BANK @ BURST LENGTH=4



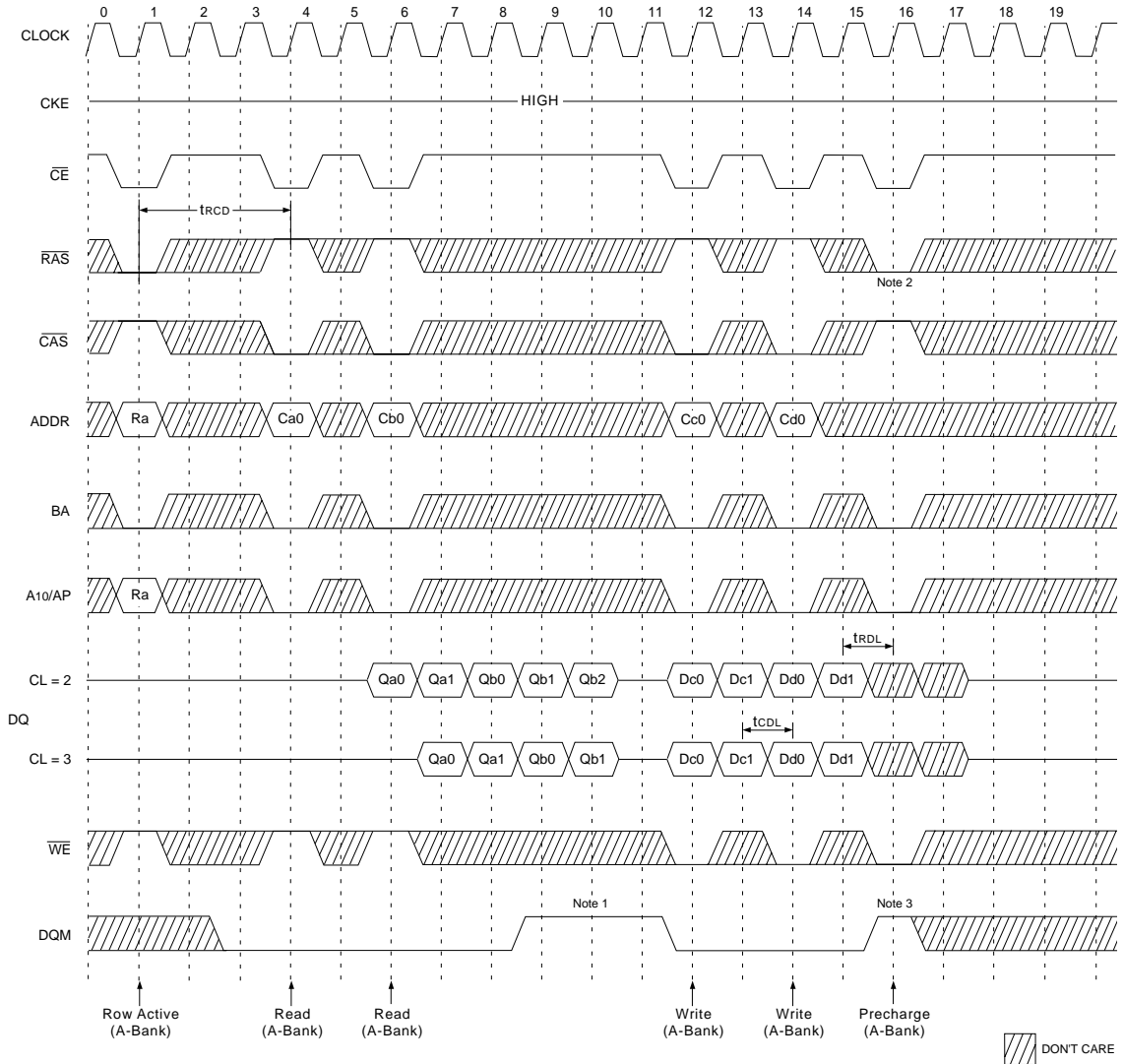
NOTES:

1. Minimum row cycle times are required to complete internal DRAM operation.
2. Row precharge can interrupt burst on any cycle. (CAS Latency - 1) number of valid output data is available after Row precharge. Last valid output will be Hi-Z(t_{SHZ}) after the clock.
3. Access time from Row active command. $t_{CC} = (t_{RCD} + \text{CAS latency} - 1) + t_{sAC}$.
4. Output will be Hi-Z after the end of burst (1, 2, 4, 8 & full page bit burst).

DONT CARE



FIG. 5 PAGE READ & WRITE CYCLE AT SAME BANK @ BURST LENGTH=4

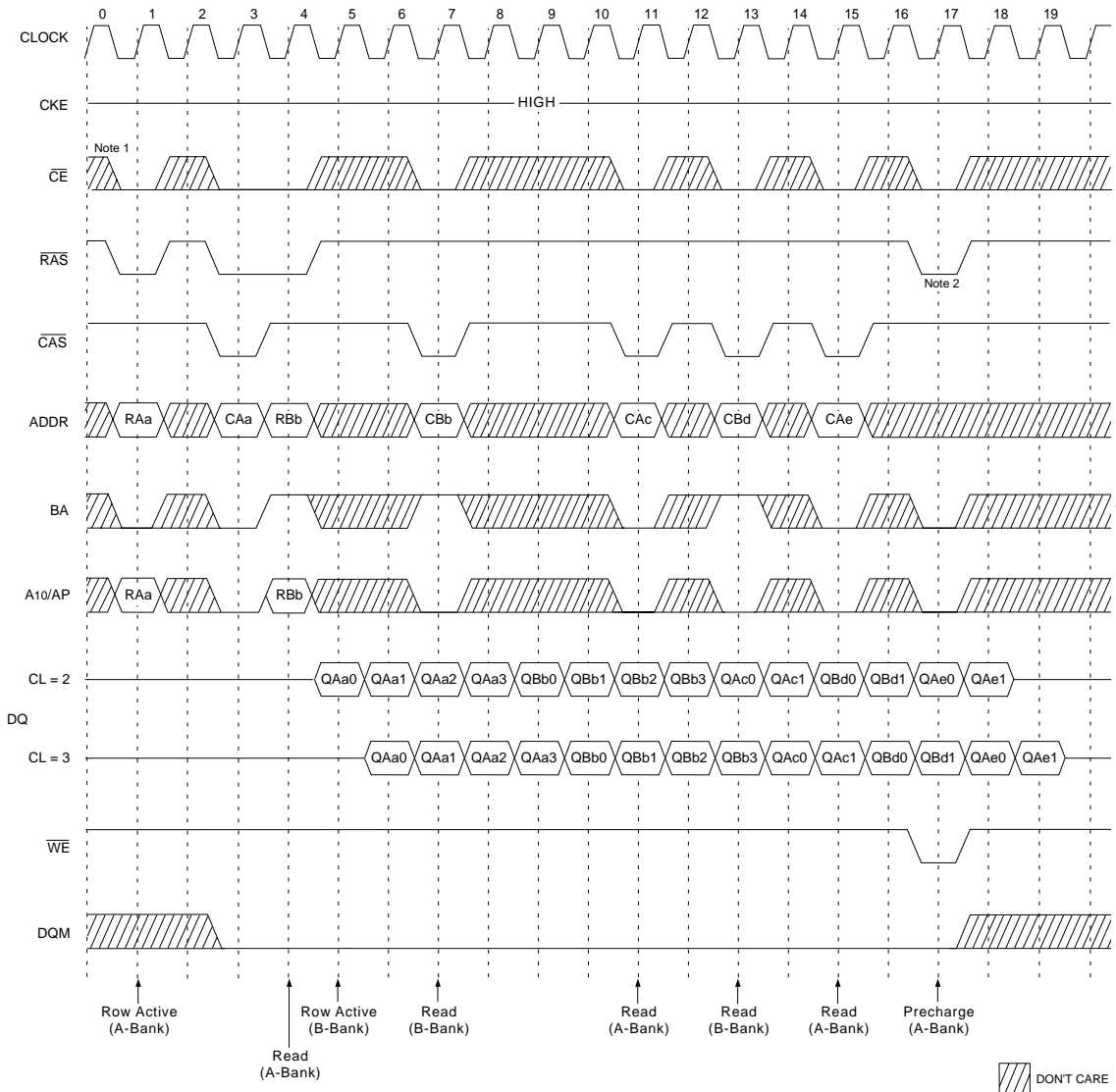


NOTES:

1. To write data before burst read ends, DQM should be asserted three cycles prior to write command to avoid bus contention.
2. Row precharge will interrupt writing. Last data input, t_{rDL} before Row precharge, will be written.
3. DQM should mask invalid input data on precharge command cycle when asserting precharge before end of burst. Input data after Row precharge cycle will be masked internally.



FIG. 6 PAGE READ CYCLE AT DIFFERENT BANK @ BURST LENGTH=4

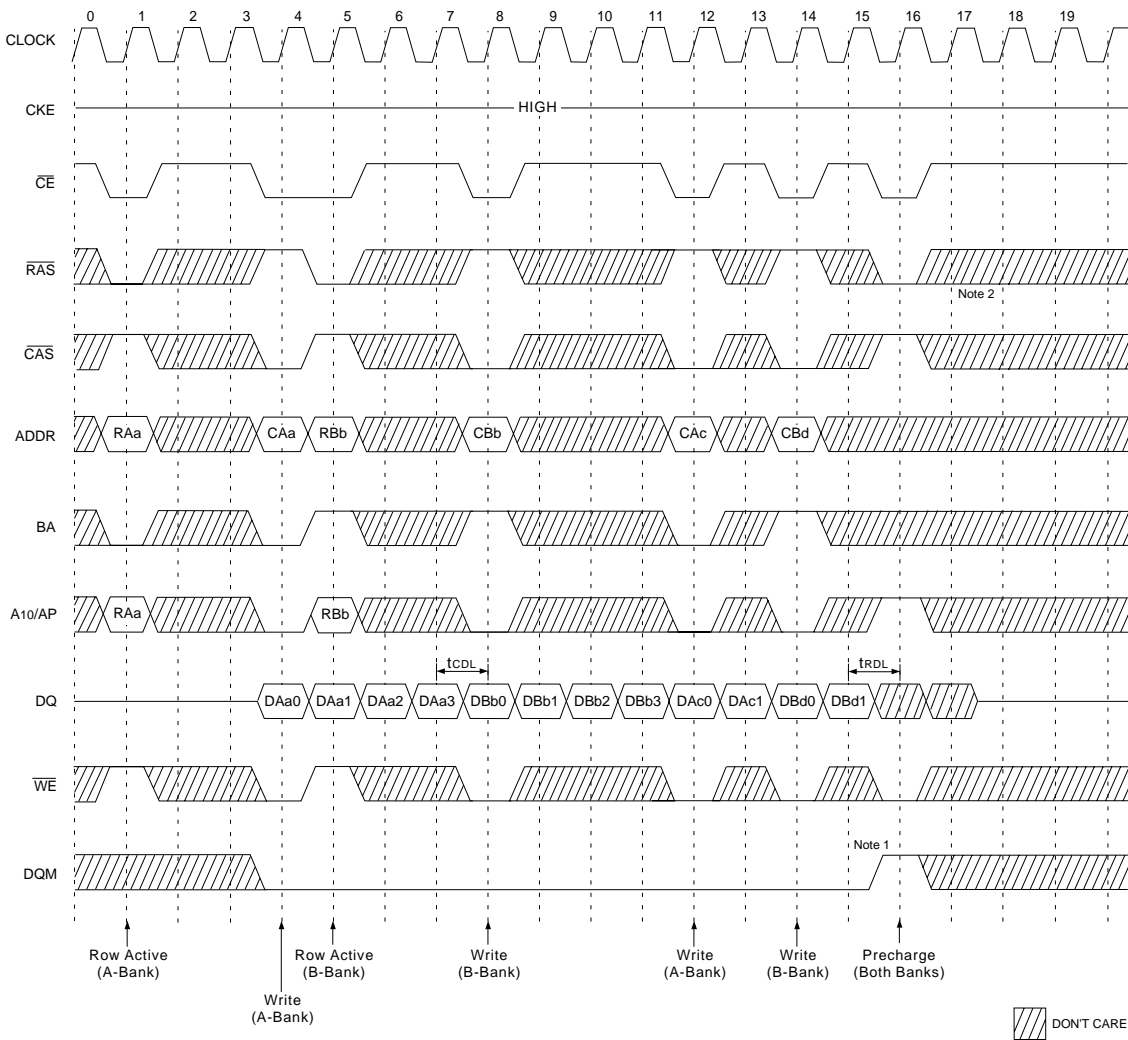


NOTES:

1. CE can be don't cared when $\overline{\text{RAS}}$, $\overline{\text{CAS}}$ and $\overline{\text{WE}}$ are high at the clock high going edge.
2. To interrupt a burst read by row precharge, both the read and the precharge banks must be the same.



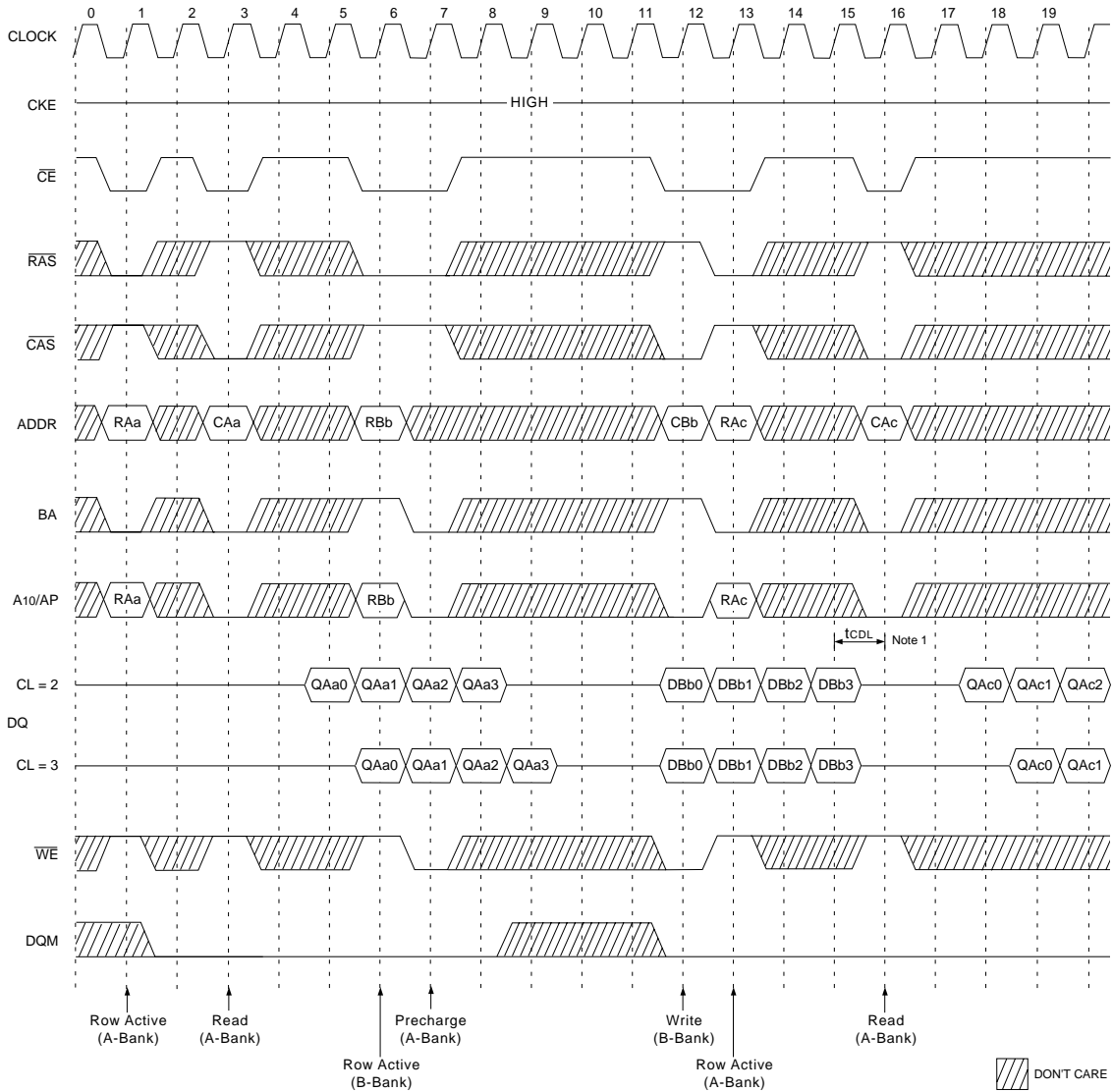
FIG. 7 PAGE WRITE CYCLE AT DIFFERENT BANK @ BURST LENGTH=4



- NOTES:
1. To interrupt burst write by Row precharge, DQM should be asserted to mask invalid input data.
 2. To interrupt burst write by Row precharge, both the write and the precharge banks must be the same.



FIG. 8 READ & WRITE CYCLE AT DIFFERENT BANK @ BURST LENGTH=4

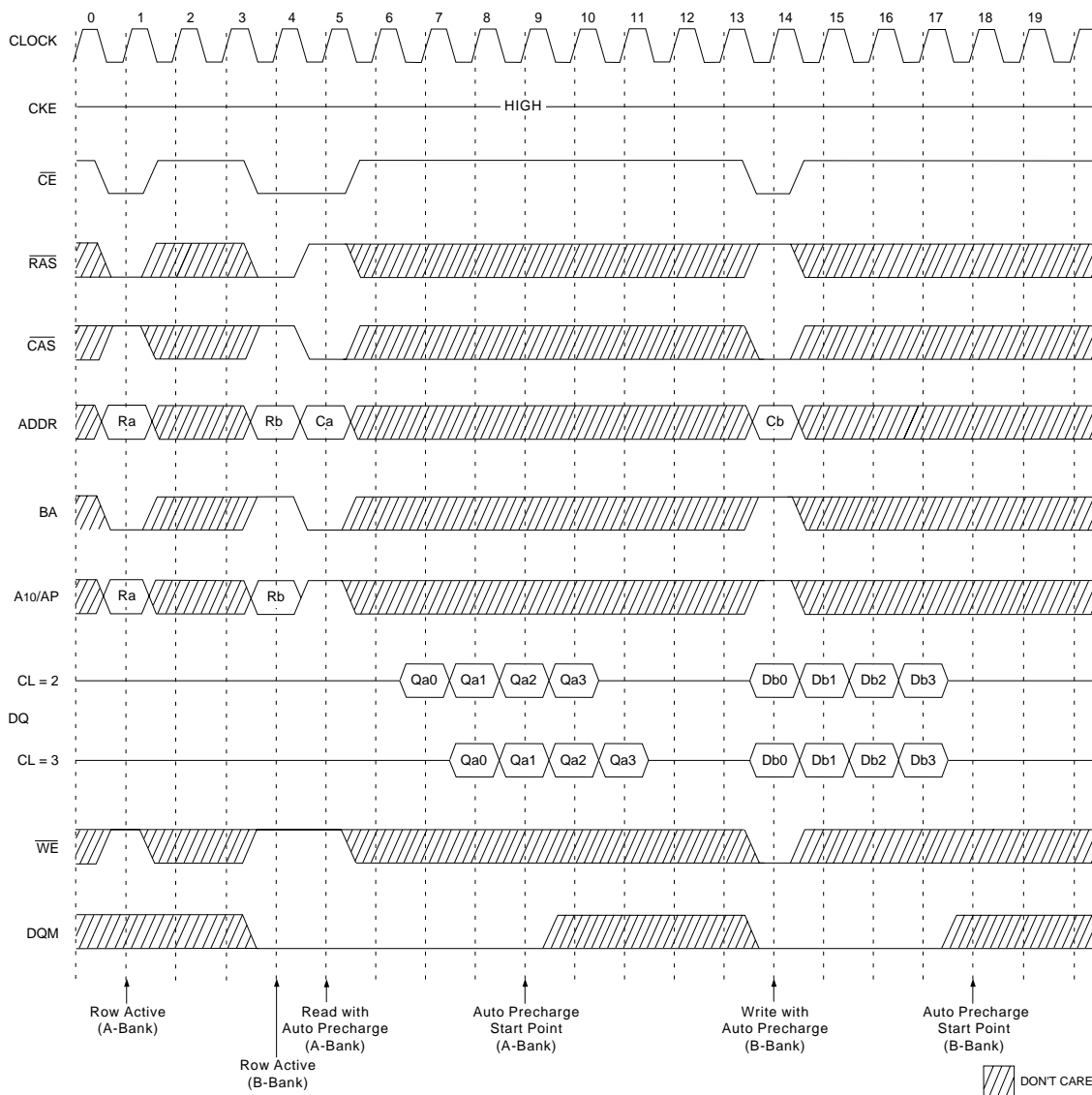


NOTE:

1. t_{CDL} should be met to complete write.



FIG. 9 READ & WRITE CYCLE WITH AUTO PRECHARGE @ BURST LENGTH=4

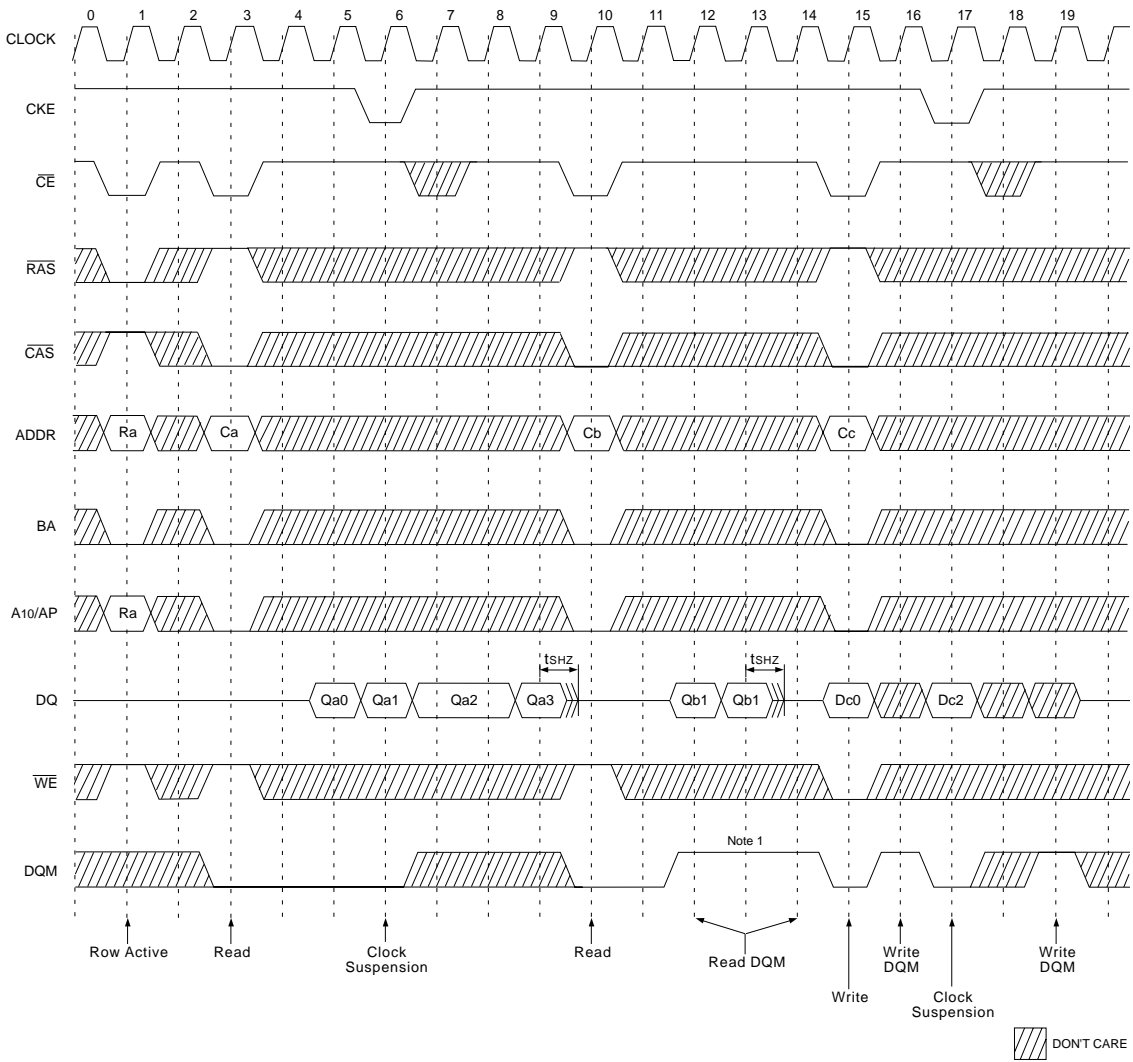


Note:

1. t_{CDL} should be controlled to meet minimum t_{RAS} before internal precharge start. (In the case of Burst Length=1 & 2 and BRSW mode)



FIG. 10 CLOCK SUSPENSION & DQM OPERATION CYCLE @ CAS LATENCY=2, BURST LENGTH=4

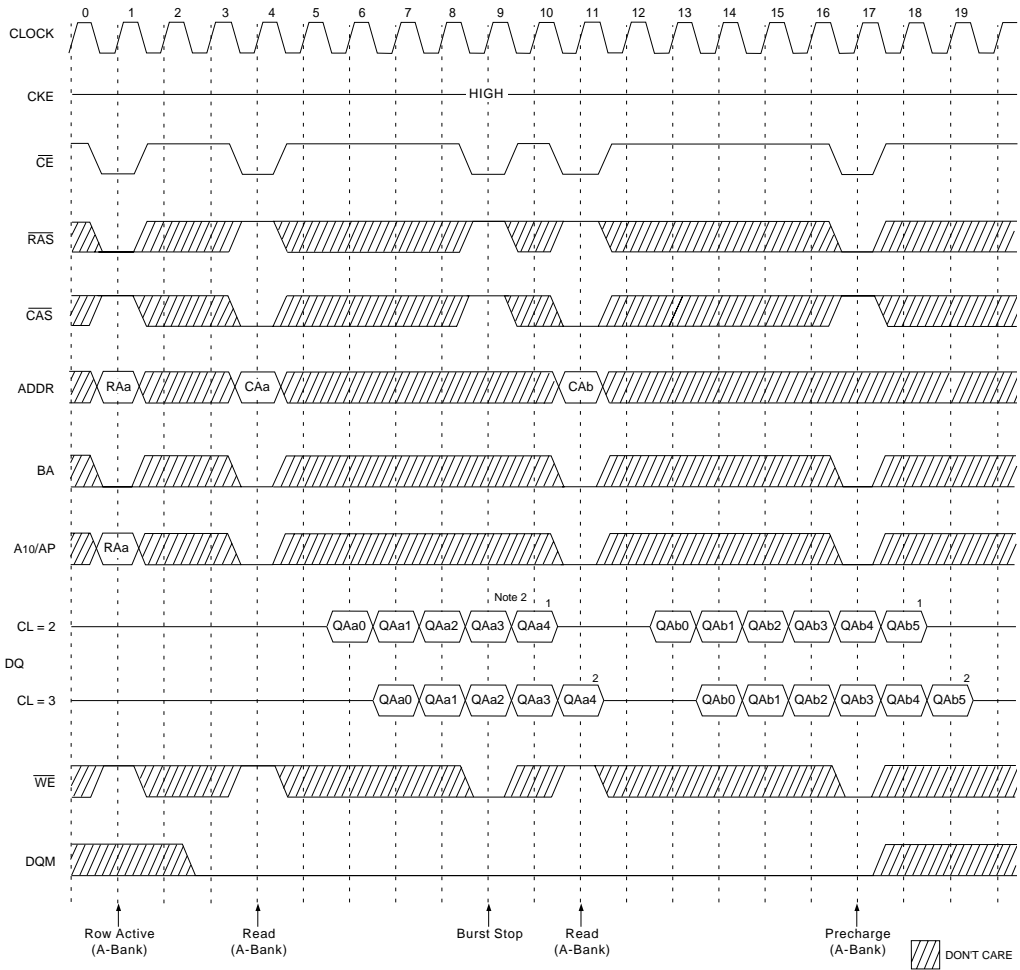


Note:

1. DQM is needed to prevent bus contention.



FIG. 11 READ INTERRUPTED BY PRECHARGE COMMAND & READ BURST STOP @ BURST LENGTH=FULL PAGE

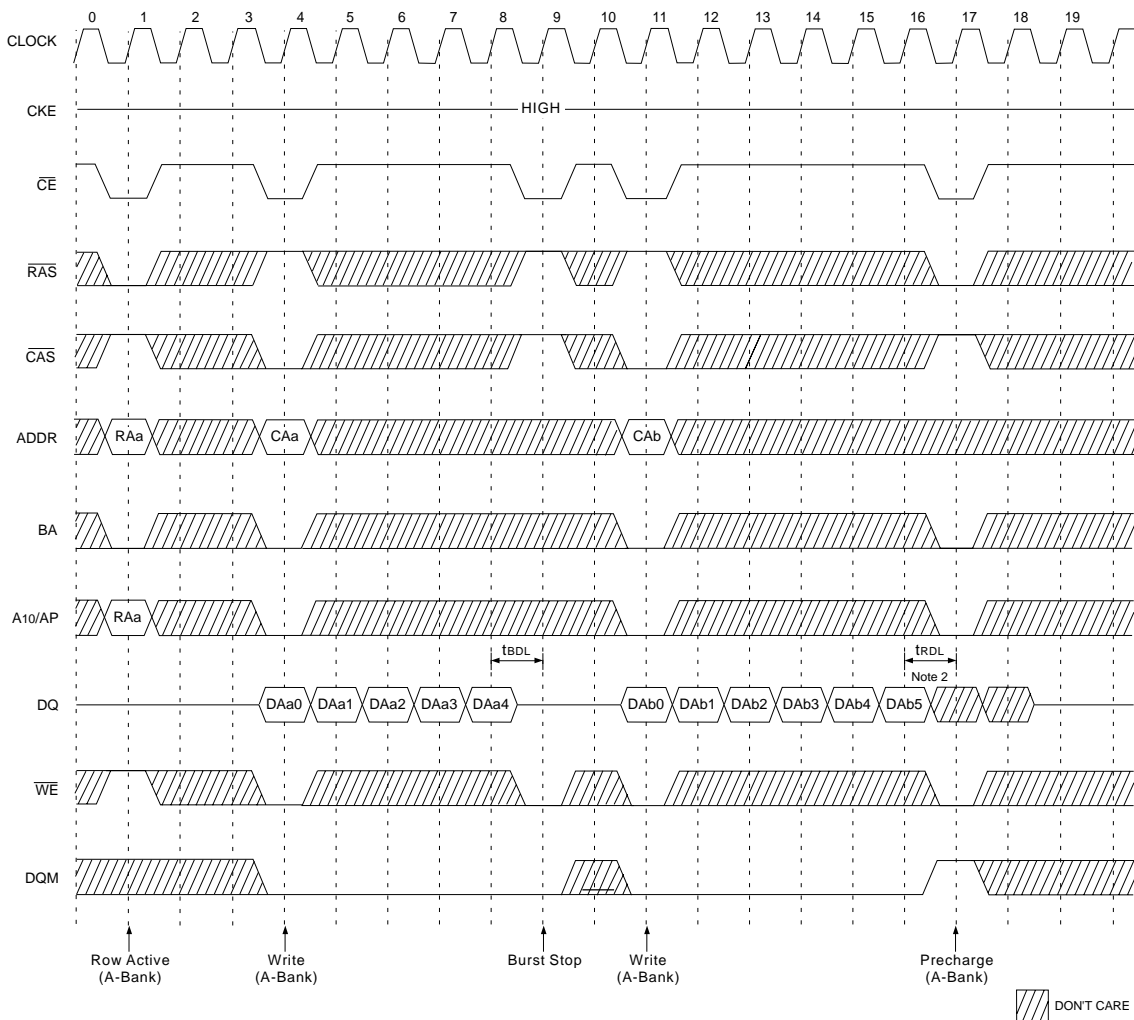


NOTES:

1. At full page mode, burst is end at the end of burst. So auto precharge is possible.
2. About the valid DQs after burst stop, it is same as the case of RAS interrupt. Both cases are illustrated in above timing diagram. See the label 1, 2. But at burst write, Burst stop and RAS interrupt should be compared carefully. Refer to the timing diagram of "Full page write burst stop cycle."
3. Burst stop is valid at every burst length.



FIG. 12 WRITE INTERRUPTED BY PRECHARGE COMMAND & WRITE BURST STOP CYCLE @ BURST LENGTH=FULL PAGE

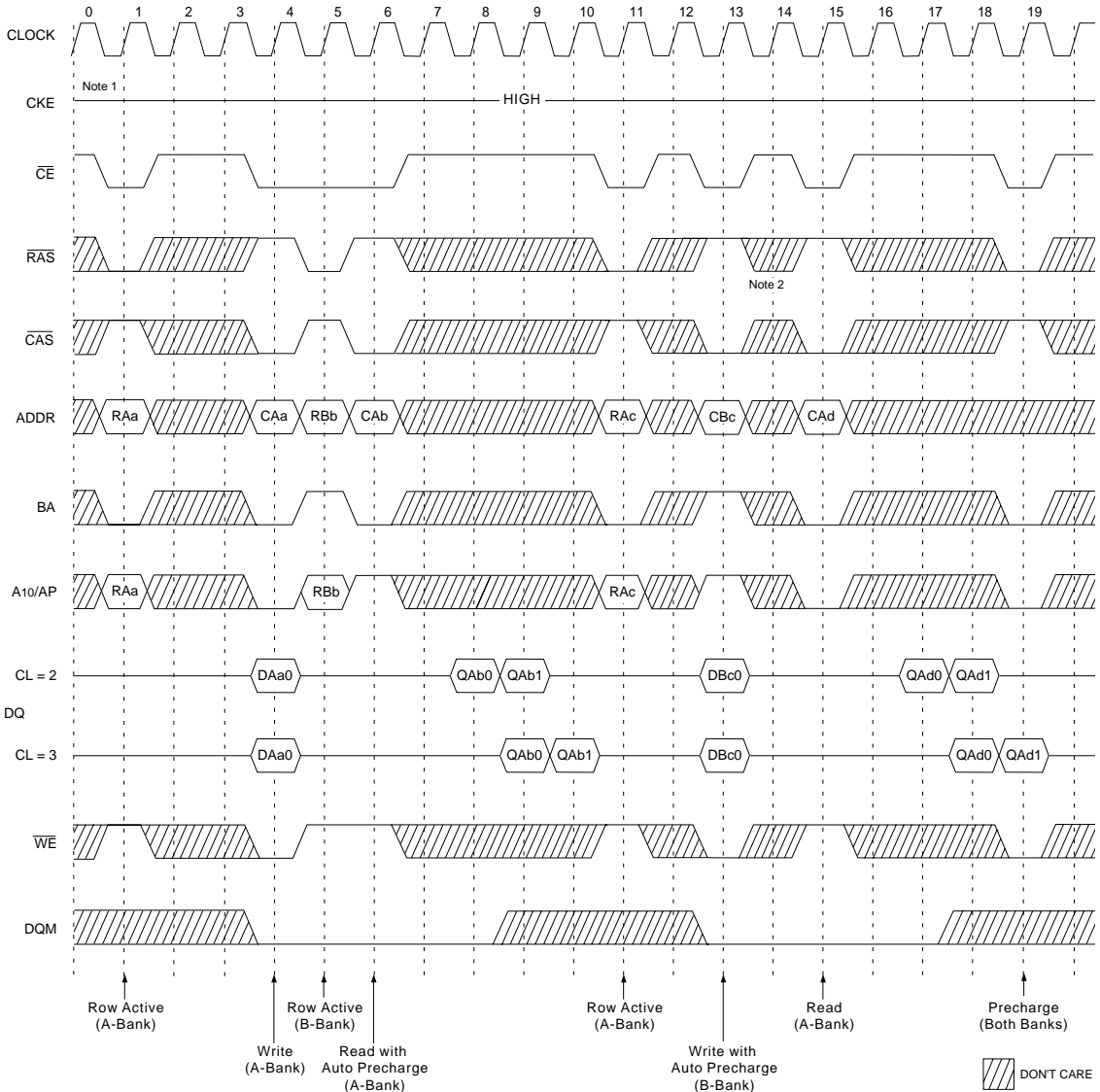


NOTES:

1. At full page mode, burst is end at the end of burst. So auto precharge is possible.
2. Data-in at the cycle of interrupted by precharge cannot be written into the corresponding memory cell. It is defined by AC parameter of tRDL. DQM at write interrupted by precharge command is needed to prevent invalid write. DQM should mask invalid input data on precharge command cycle when asserting precharge before end of burst. Input data after Row precharge cycle will be masked internally.
3. Burst stop is valid at every burst length.



FIG. 13 BURST READ SINGLE BIT WRITE CYCLE @ BURST LENGTH=2

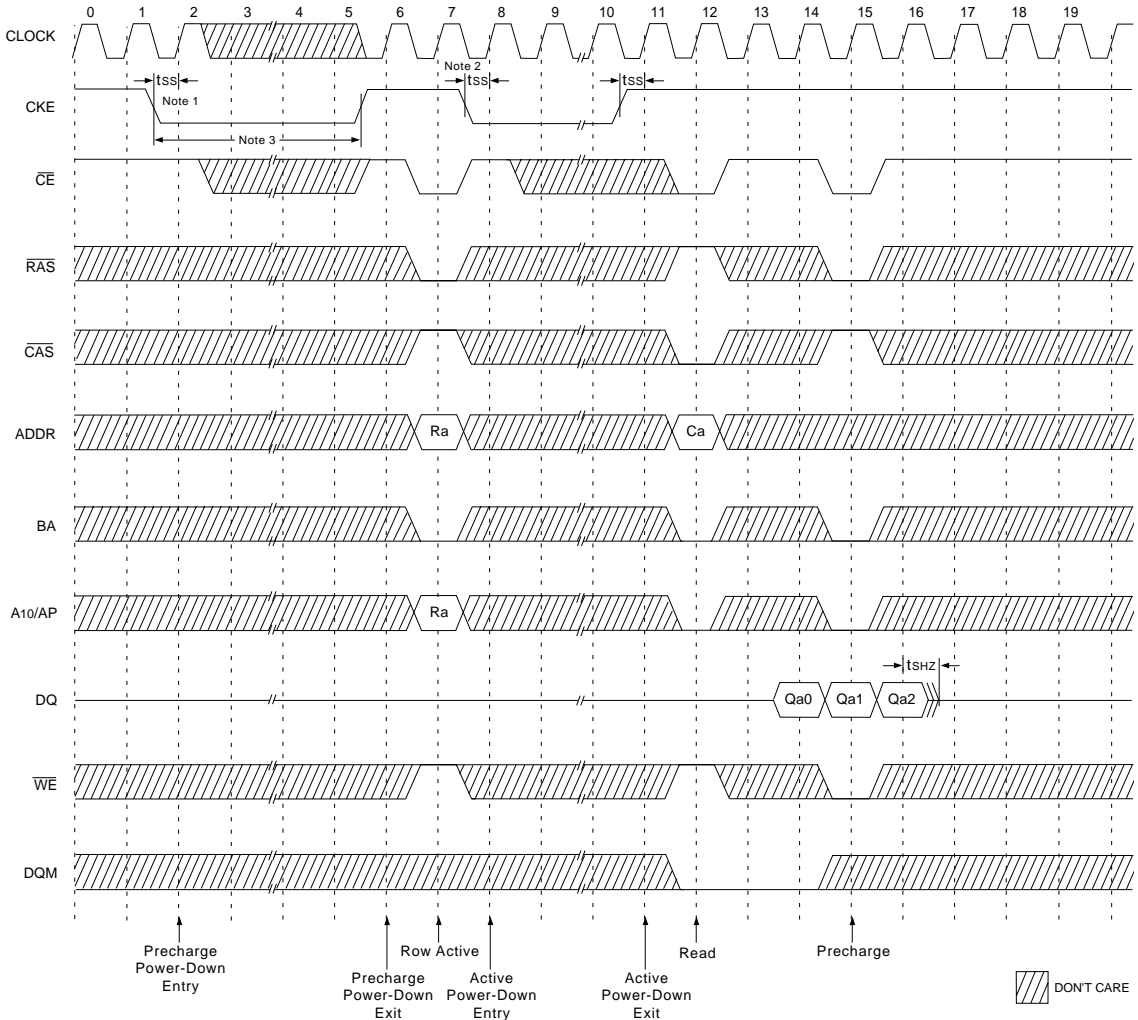


NOTES:

1. BRSW mode is enabled by setting As "High" at MRS (Mode Register Set). At the BRSW Mode, the burst length at write is fixed to "1" regardless of programmed burst length.
2. When BRSW write command with auto precharge is executed, keep in mind that t_{RAS} should not be violated. Auto precharge is executed at the burst-end cycle, so in the case of BRSW write command, the next cycle starts the precharge.



FIG. 14 ACTIVE/PRECHARGE POWER DOWN MODE @ CAS LATENCY=2, BURST LENGTH=4

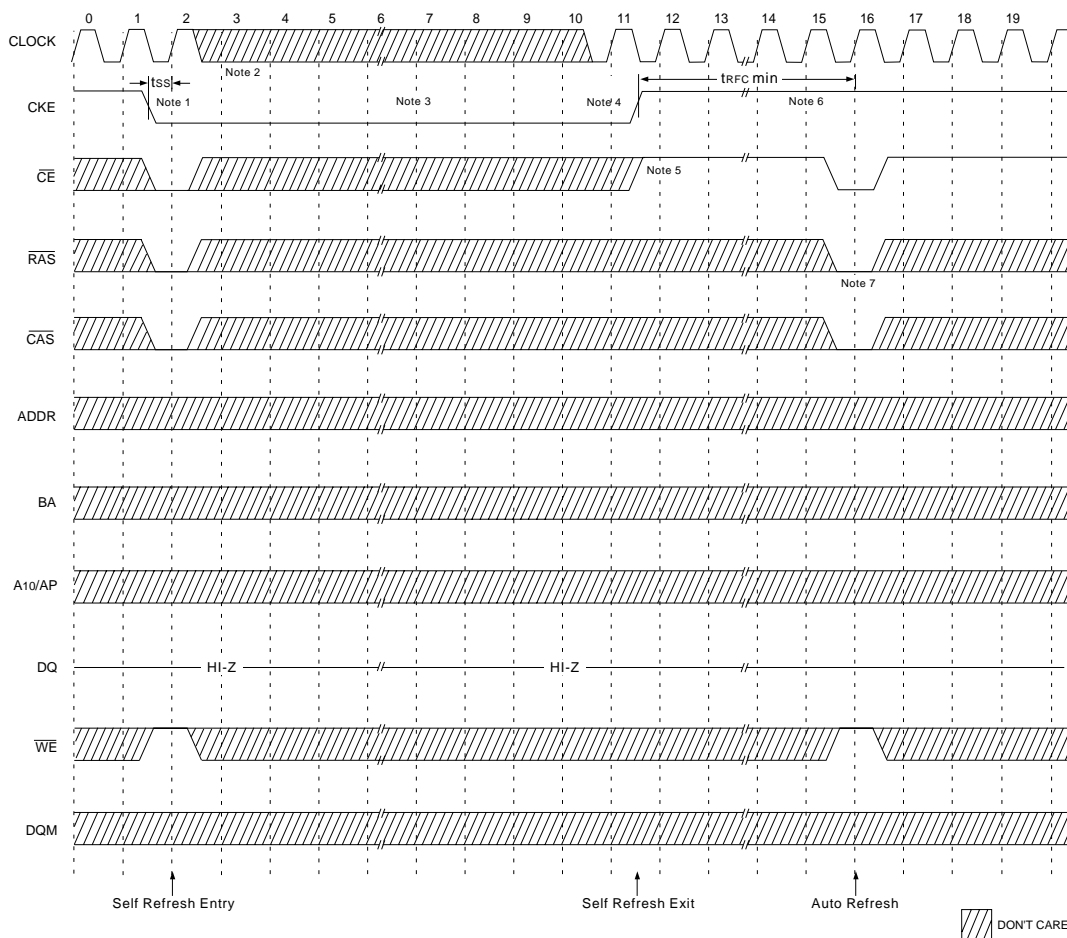


NOTES:

1. Both banks should be in idle state prior to entering precharge power down mode.
2. CKE should be set high at least 1CLK + tss prior to Row active command.
3. Can not violate minimum refresh specification (64ms).



FIG. 15 SELF REFRESH ENTRY & EXIT CYCLE



NOTES:

TO ENTER SELF REFRESH MODE

1. \overline{CE} , \overline{RAS} & \overline{CAS} with \overline{CKE} should be low at the same clock cycle.
2. After 1 clock cycle, all the inputs including the system clock can be don't care except for \overline{CKE} .
3. The device remains in self refresh mode as long as \overline{CKE} stays "Low." Once the device enters self refresh mode, minimum t_{RAS} is required before exit from self refresh.

TO EXIT SELF REFRESH MODE

4. System clock restart and be stable before returning \overline{CKE} high.
5. \overline{CE} starts from high.
6. Minimum t_{RFC} is required after \overline{CKE} going high to complete self refresh exit.
7. 4K cycle of burst auto refresh is required before self refresh entry and after self refresh exit if the system uses burst refresh.



FIG. 16 MODE REGISTER SET CYCLE

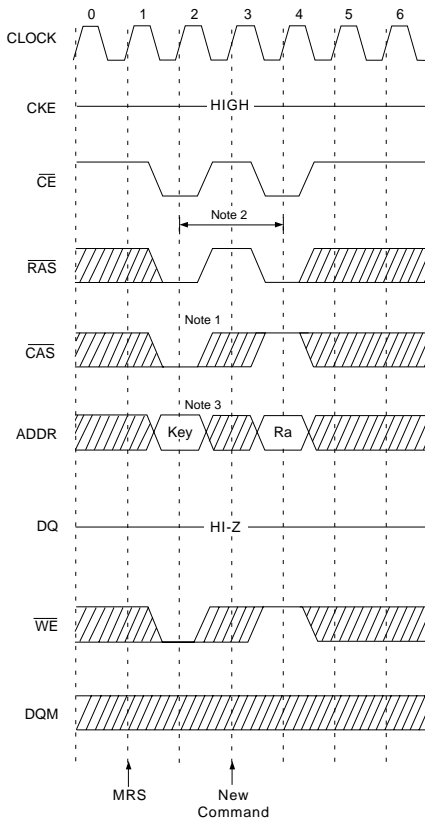
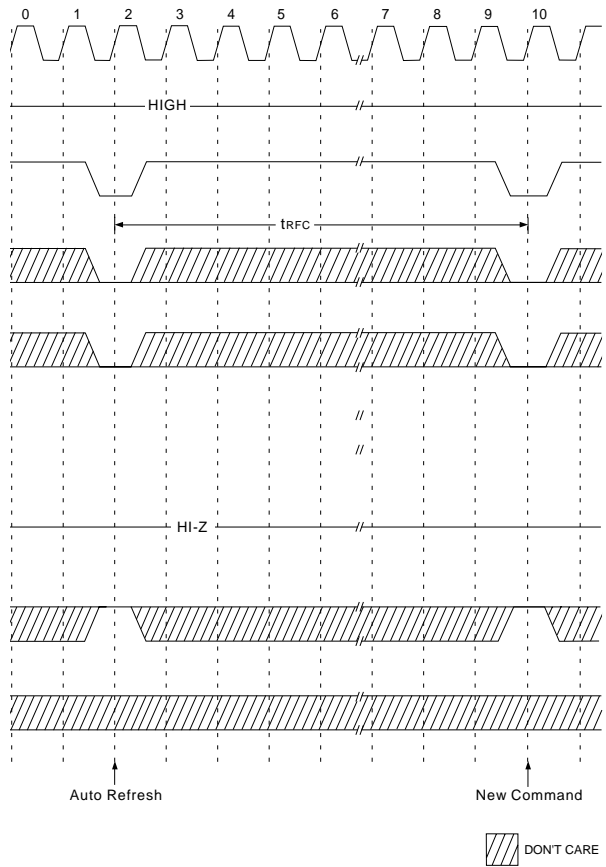


FIG. 17 AUTO REFRESH CYCLE



NOTES:

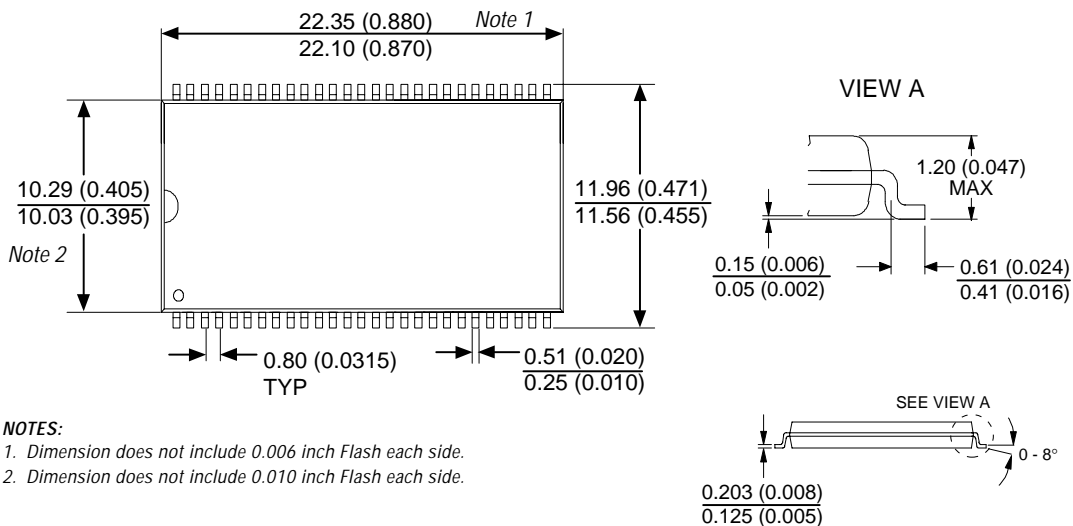
Both banks precharge should be completed before Mode Register Set cycle and auto refresh cycle.

MODE REGISTER SET CYCLE

1. CE, RAS, CAS, & WE activation at the same clock cycle with address key will set internal mode register.
2. Minimum 2 clock cycles should be met before new $\overline{\text{RAS}}$ activation.
3. Please refer to Mode Register Set table.



PACKAGE DIMENSION: 54 PIN TSOP II



ALL LINEAR DIMENSIONS ARE IN MILLIMETERS AND PARENTHEMICALLY IN INCHES

ORDERING INFORMATION

Part Number	Organization	Operating Frequency	Package
WED416S8030A10SI	2Mx16bitsx4banks	100MHz	54 TSOP II
WED416S8030A12SI	2Mx16bitsx4banks	83MHz	54 TSOP II